



# PESD5V0C2UM-Q

Extremely low capacitance unidirectional ESD protection diode array

25 May 2022

Product data sheet

## 1. General description

Extremely low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode array, part of the TrEOS protection family. This device is housed in a DFN1006-3 (SOT883-2) leadless ultra small Surface-Mounted Device (SMD) plastic package, designed to protect up to two signal lines from the damage caused by ESD and other transients.

## 2. Features and benefits

- Unidirectional ESD protection of one line pair
- $V_{RWM} = 5\text{ V}$  device
- Very high surge robustness of 6.5 A for a 8/20  $\mu\text{s}$  pulse
- Very low diode capacitance:  $C_d = 0.5\text{ pF}$  typical
- Extremely low clamping voltage to protect sensitive I/Os
- ESD protection up to  $\pm 15\text{ kV}$  according to IEC 61000-4-2
- Leadless ultra small SOT883-2 surface mount package
- IEC61000-4-4 robust up to level 4 (corresponds to 40 A into a 50 Ohm termination)
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

ESD protection for in-vehicle network lines in automotive environments

- High-speed data lines such USB2.0 and USB3.0 up to 5 Gbps
- Low-Voltage Differential Signaling (LVDS) automotive
- Automotive A/V monitors, display and cameras

## 4. Quick reference data

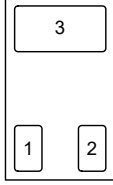
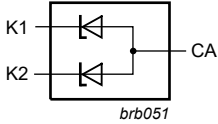
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{RWM}$	reverse standoff voltage		[1]	-	-	5	V
$C_d$	diode capacitance	$f = 1\text{ MHz}; V_R = 0\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$	[1]	-	0.5	0.6	pF

[1] Measured from pin 1 or 2 to pin 3.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	 <p>Transparent top view <b>DFN1006-3 (SOT883-2)</b></p>	 <p><i>brb051</i></p>
2	K2	cathode (diode 2)		
3	CA	common anode		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PESD5V0C2UM-Q	DFN1006-3	Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.47 mm	SOT883-2

## 7. Marking

Table 4. Marking codes

Type number	Marking code
PESD5V0C2UM-Q	6B

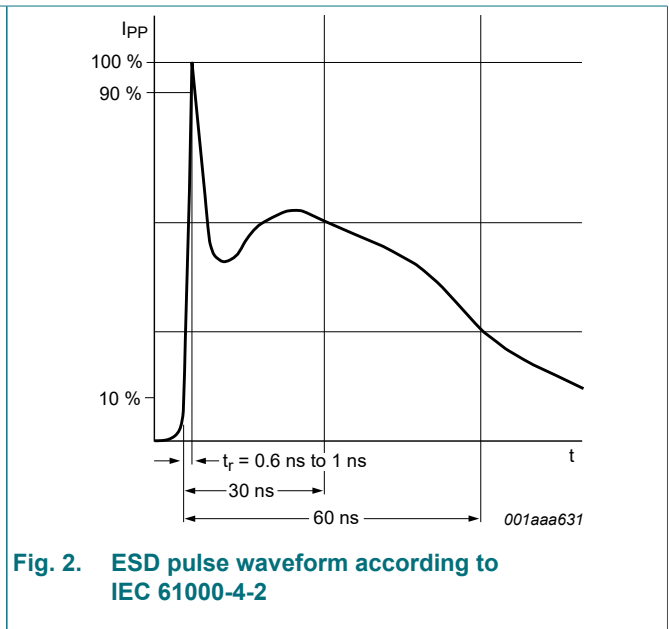
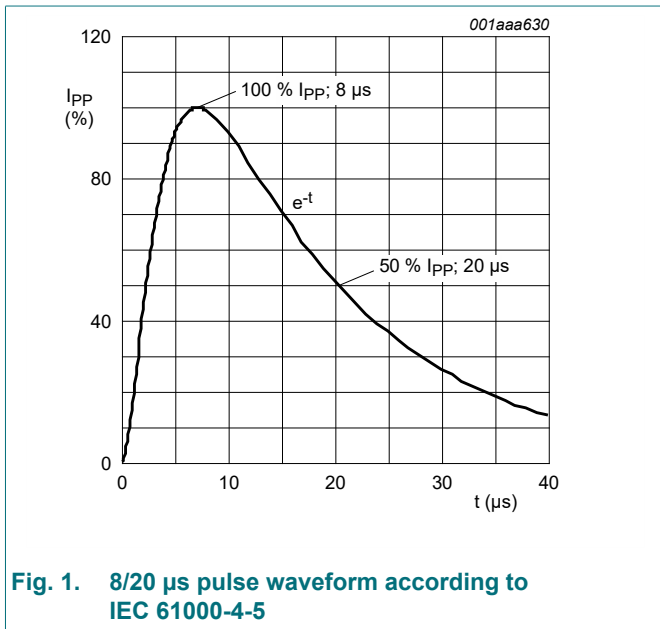
## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{RWM}$	reverse standoff voltage		[1]	-	5	V
$I_{PPM}$	rated peak pulse current	$t_p = 8/20 \mu s$	[1] [2]	-6.5	6.5	A
$T_{amb}$	ambient temperature			-55	150	°C
$T_{stg}$	storage temperature			-65	150	°C
<b>ESD maximum ratings</b>						
$V_{ESD}$	electrostatic discharge voltage	IEC 61000-4-2; contact discharge	[1] [3]	-15	15	kV
		IEC 61000-4-2; air discharge	[1] [3]	-15	15	kV

- [1] Measured from pin 1 or 2 to pin 3.
- [2] Non-repetitive current pulse 8/20  $\mu s$  exponentially decaying waveform according to IEC 61000-4-5.
- [3] Device stressed with ten non-repetitive ESD pulses.



## 9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$V_{BR}$	breakdown voltage	$I_R = 1 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$	[1]	-	8	-	V
$I_{RM}$	reverse leakage current	$V_{RWM} = 4 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$	[1]	-	1	50	nA
$C_d$	diode capacitance	$f = 1 \text{ MHz}; V_R = 0 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$	[1]	-	0.5	0.6	pF
$V_{CL}$	clamping voltage	$I_{TLP} = 8 \text{ A}; t_p = 100 \text{ ns}; T_{amb} = 25 \text{ }^\circ\text{C}$	[1] [2]	-	3.2	-	V
		$I_{TLP} = 16 \text{ A}; t_p = 100 \text{ ns}; T_{amb} = 25 \text{ }^\circ\text{C}$	[1] [2]	-	5	-	V
		$I_{PPM} = 6.5 \text{ A}; t_p = 8/20 \text{ } \mu\text{s}; T_{amb} = 25 \text{ }^\circ\text{C}$	[1] [3]	-	3.4	-	V
$R_{dyn}$	dynamic resistance	$I_R = 10 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$	[1] [2]	-	0.27	-	$\Omega$
		$I_R = -10 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$	[1] [2]	-	0.27	-	$\Omega$
$f_{-3dB,dd}$	differential cut-off frequency	normalized to attenuation at 1 MHz; $T_{amb} = 25 \text{ }^\circ\text{C}$	[1]	-	5.8	-	GHz

[1] Measured from pin 1 or 2 to pin 3.

[2] Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.5.1-2008

[3] Device stressed with 8/20  $\mu\text{s}$  exponential decay waveform according to IEC 61000-4-5

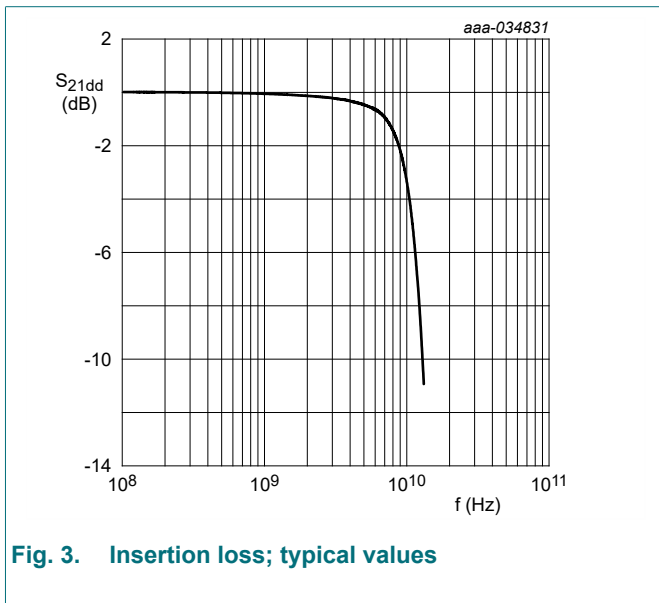


Fig. 3. Insertion loss; typical values

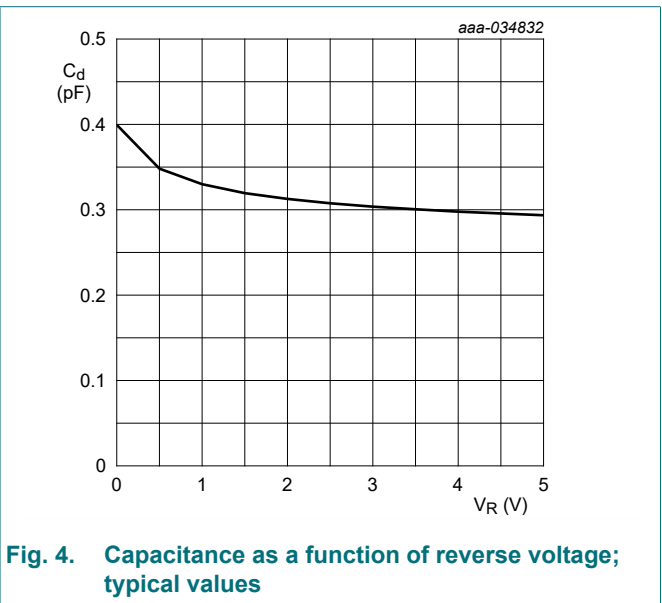
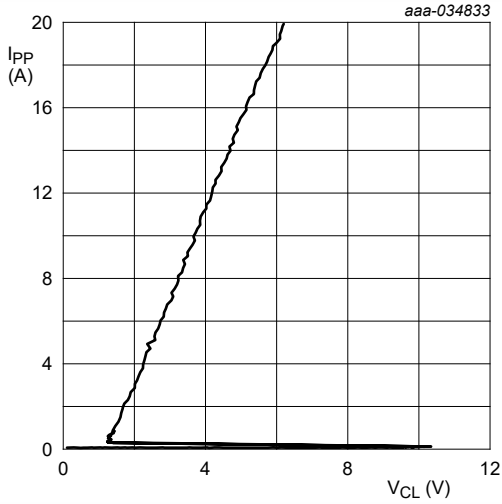


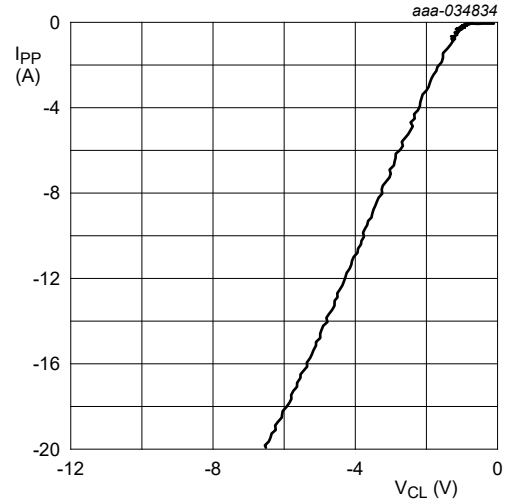
Fig. 4. Capacitance as a function of reverse voltage; typical values

Extremely low capacitance unidirectional ESD protection diode array



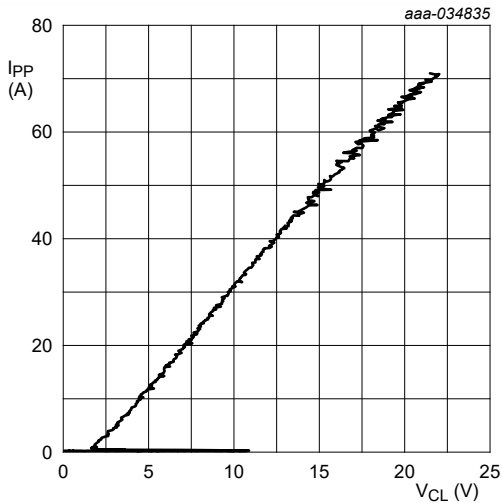
Transmission Line Pulse (TLP);  
 $t_p = 100 \text{ ns}$ ;  $t_r = 1 \text{ ns}$

**Fig. 5. Dynamic resistance with positive clamping; typical values**



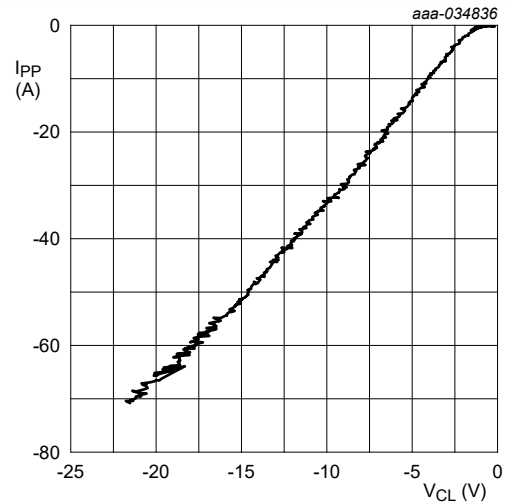
Transmission Line Pulse (TLP);  
 $t_p = 100 \text{ ns}$ ;  $t_r = 1 \text{ ns}$

**Fig. 6. Dynamic resistance with negative clamping; typical values**



Very-Fast Transmission Line Pulse (VF-TLP);  
 $t_p = 5 \text{ ns}$ ;  $t_r = 600 \text{ ps}$

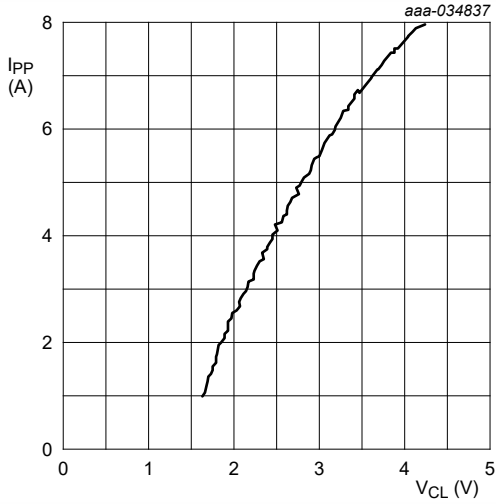
**Fig. 7. Dynamic resistance with positive clamping; typical values**



Very-Fast Transmission Line Pulse (VF-TLP);  
 $t_p = 5 \text{ ns}$ ;  $t_r = 600 \text{ ps}$

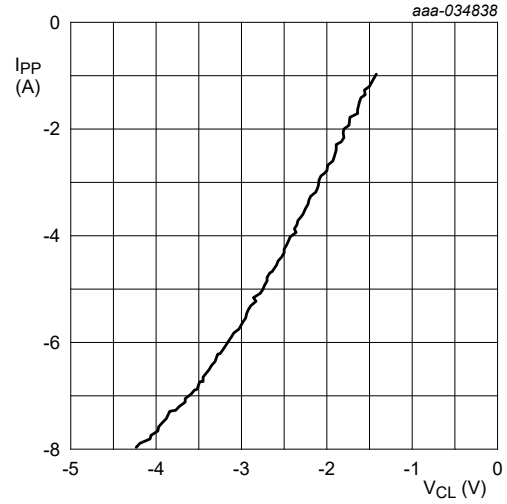
**Fig. 8. Dynamic resistance with negative clamping; typical values**

Extremely low capacitance unidirectional ESD protection diode array



IEC 61000-4-5;  $t_p = 8/20 \mu s$ ; positive pulse

**Fig. 9. Dynamic resistance with positive clamping; typical values**



IEC 61000-4-5;  $t_p = 8/20 \mu s$ ; negative pulse

**Fig. 10. Dynamic resistance with negative clamping; typical values**

## 10. Application information

The device is designed for the protection of two uni-directional or one bi-directional data or signal lines from surge pulses and ESD damage.

The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).

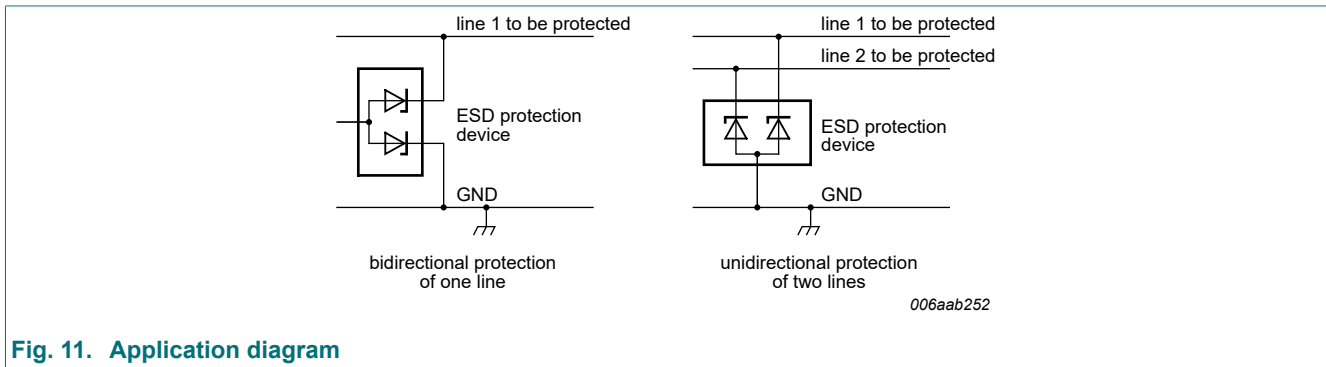


Fig. 11. Application diagram

### Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

1. Place the device as close to the input terminal or connector as possible.
2. Minimize the path length between the device and the protected line.
3. Keep parallel signal paths to a minimum.
4. Avoid running protected conductors in parallel with unprotected conductors.
5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
6. Minimize the length of the transient return path to ground.
7. Avoid using shared transient return paths to a common ground point.
8. Use ground planes whenever possible. For multilayer PCBs, use ground vias.

## 11. Test information

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 12. Package outline

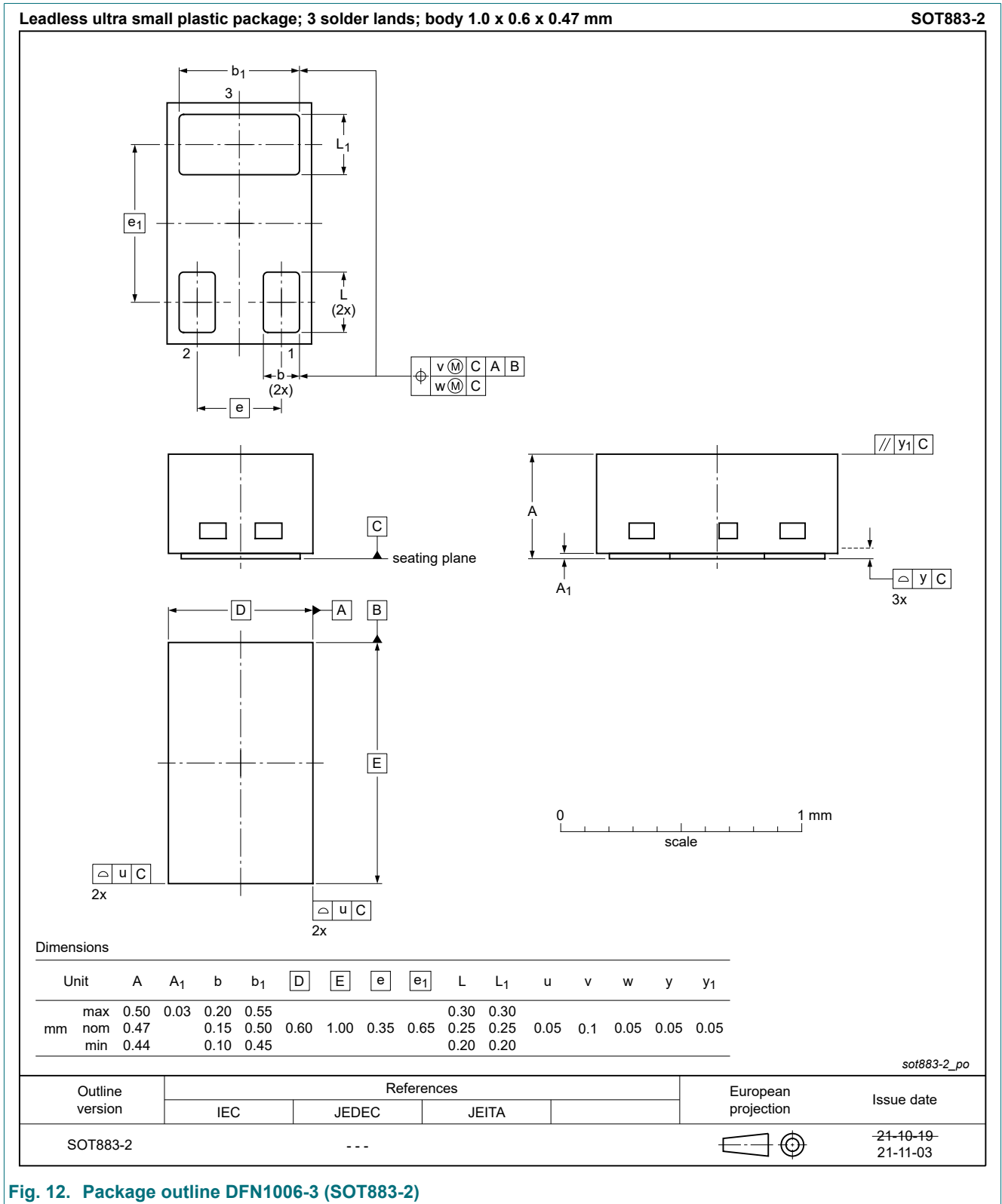


Fig. 12. Package outline DFN1006-3 (SOT883-2)



### 13. Soldering

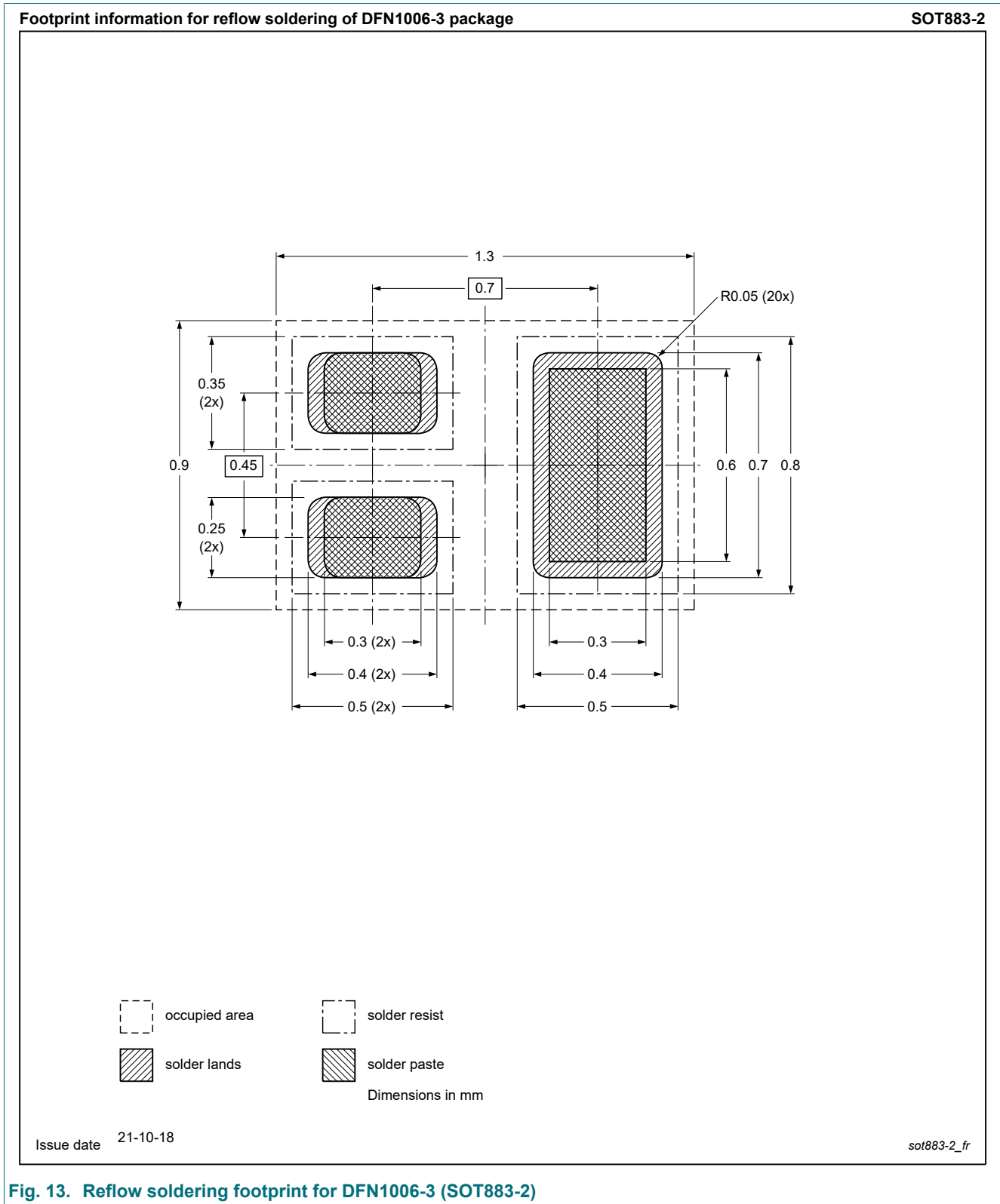


Fig. 13. Reflow soldering footprint for DFN1006-3 (SOT883-2)

## 14. Revision history

Table 7. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PESD5V0C2UM-Q v.2	20220525	Product data sheet	-	PESD5V0C2UM-Q v.1
Modifications:	• Typo correction: package version set to SOT883-2			
PESD5V0C2UM-Q v.1	20220520	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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